APPLICATION UNDER UNITED STATES PATENT LAWS

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Invention: DIFFERENTIAL SIGNALING TRANSMISSION CIRCUIT

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This is a:

☐ Provisional Application

☒ Regular Utility Application

☐ Continuing Application
  ☐ The contents of the parent are incorporated
    by reference

☐ PCT National Phase Application

☐ Design Application

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  Sub. Spec. filed _____
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SPECIFICATION

DIFFERENTIAL SIGNALING TRANSMISSION CIRCUIT

RELATED APPLICATIONS

[0001] This application claims priority to United States Provisional Patent Application No. 60/399,711, filed August 1, 2002 and entitled "LOW VOLTAGE DIFFERENTIAL SIGNALING DRIVERS WITH IMPROVED MATCHING CHARACTERISTICS".

FIELD OF THE INVENTION

[0002] The present invention relates to signal transmission over conductive structure.

BACKGROUND

[0003] It is desirable to convey data signals in a manner that provides relatively high speed while consuming relatively little power. Differential signaling modes such as low voltage differential signaling (LVDS) are used for many such applications. The rejection of common-mode noise inherent in a differential scheme allows for implementations having low power consumption, and the low voltage swing in an LVDS application allows for high-speed transmission. Moreover, drivers for such systems may be implemented in CMOS (complementary metal–oxide–semiconductor or "MOS"), which process provides low static power consumption.

[0004] Differential signaling circuits may be used to drive paired or unpaired transmission lines such as twisted pair cable, conductors in ribbon cable, or parallel traces on a circuit board. Differential signaling systems also tend to produce relatively little noise (electromagnetic interference or "EMI")

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to interfere with other devices or signaling lines. Applications for differential signaling and LVDS include transmission of images (e.g. within a digital camera, or between a camera and a host), transmission of video images (e.g. from a host computer or processor to a display screen (such as within a laptop computer or a flat-panel display device), or over a distance of meters), and other high-speed transmissions of data (e.g. a high-speed disk storage interface).

[0005] In summary, a low voltage differential signaling scheme may provide numerous advantages such as reduced power consumption, lower EMI emissions, good rejection on common-mode noise, less expensive cable interface, and simplified transmitter design. FIGURE 1 shows a structure of an LVDS input/output interface, which illustrates the low current, low termination impedance, and low voltage swing of such a scheme. Documents that define LVDS transmission schemes include the ANSI/TIA/EIA-644 standard, the IEEE 1596.3 standard (Scalable Coherent Interface LVDS or "SCI-LVDS"), and subsequent revisions thereof.

[0006] FIGURE 2 shows one implementation of a LVDS driver circuit. In this circuit, N-channel MOS field-effect transistors (FETs) NP1, NP2, NS1, and NS2 are used to switch current through a load R1. In response to the input signals SN and SP changing signal states, these four transistors act as current-steering cells to switch the direction of a driving current (provided by current source CSR1) and offer a differential output signal to the resistive load. Current returning from the load is passed to current sink CSK1.

[0007] FIGURE 3 shows a circuit including two digital inverters that may be used to generate input signals SN and SP for the circuit of FIGURE 2 from a single digital signal.

[0008] FIGURE 4 shows a diagram of the circuit of FIGURE 2 that illustrates how the current source CSR1 and current sink CSK1 have actually

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been implemented previously (where CMC indicates a current mirroring circuit). In order to maintain a desired offset voltage, the driver circuit of FIGURE 4 includes a mimicking circuit consisting of three regulating opamps (X1, X2, and X3); two series resistors R2, R3; and current sourcing and switching transistor cells PC1, NC1.

[0009] FIGURE 5 shows an alternate LVDS driver circuit in which an offset voltage V_{off} is applied between a pair of series source-termination resistors R4, R5. FIGURE 6 shows a circuit that may be used to generate analog differential signals to drive the circuit of FIGURE 5, and FIGURE 7 shows a diagram of the circuit of FIGURE 5 that illustrates how the current source CSP and current sink CSN have actually been implemented previously, using a particular current mirror configuration.

BRIEF DESCRIPTION OF THE DRAWINGS

[0010] FIGURE 1 depicts an example of an LVDS input/output interface;

[0011] FIGURE 2 shows an LVDS driver circuit;

[0012] FIGURE 3 shows a digital control circuit for use with the driver circuit of FIGURE 2;

[0013] FIGURE 4 shows an LVDS driver circuit that includes a mimicking circuit;

[0014] FIGURE 5 shows an LVDS driver circuit;

[0015] FIGURE 6 shows an analog differential control signal generator for use with the driver circuit of FIGURE 5;

[0016] FIGURE 7 shows an implementation of the driver circuit of FIGURE 5;

[0017] FIGURE 8 shows a model of the driver circuit of FIGURE 7;

[0018] FIGURE 9 shows a circuit according to an embodiment of the invention;

[0019] FIGURE 10 shows an implementation of the circuit of FIGURE 9;

[0020] FIGURE 11 is a block diagram of an output driver topology according to an alternative embodiment of the present invention;

[0021] FIGURE 12 illustrates a signal generator circuit according to an embodiment of the present invention;

[0022] FIGURE 13 shows an implementation of the circuit of FIGURE 12;

[0023] FIGURE 14 shows a timing diagram for the circuit of FIGURE 13; and

[0024] FIGURE 15 shows an implementation of the circuit of FIGURE 13.

DETAILED DESCRIPTION

[0025] The term "exemplary" as used herein indicates an example only, and should not be taken necessarily to indicate a preferred or superior value or instance.

[0026] When an LVDS driver circuit as shown in FIGURE 2 or FIGURE 4 is implemented using N-well processes, the transistors NP1 and NP2 may suffer from body effects. As a consequence, the effective "ON" resistance values for these transistors may be relatively high compared to those of similarly configured PMOS transistors with comparable sizes. The resulting voltage drops across transistors NP1 and NP2 may force the minimum required value for the power supply potential (V_{DD}) to be higher than desired.

[0027] Another drawback of an LVDS driver circuit as shown in FIGURE 4 may arise from offsets inherent in the feedback loops of the opamps X2 and X3. As a consequence of these offsets, matching the "mimicking" transistor PC0 to current source PC1, and matching the "mimicking" transistor NC0 to current sink NC1, may not be enough to ensure a matching between the current passed to current sink NC1 and the current provided by current source PC1. Rather, the current flowing out of the positive terminal of the driver to the load (and the current flowing into the negative terminal of the driver from the load) may be defined by the "ON" resistance values of the current-switching transistors NP1, NP2, NS1, NS2 and the resistance value of the load R1. Therefore, the circuit may be susceptible to a large variation of the voltage drop across R1 when there are mismatches between "mimicking" transistor NP0 and either of current-switching transistors NP1 and NP2, or between "mimicking" transistor NS0 and either of current-switching transistors NS1 and NS2.

[0028] In addition, a driver using a conventional single-ended digital control circuit as shown in FIGURE 3 may suffer from timing distortion due to mismatched rising and falling times of the SN and SP signals applied to the driver inputs.

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[0029] FIGURE 7 illustrates another LVDS driver circuit. Instead of utilizing a mimicking circuit, a driver circuit as shown in FIGURE 7 attempts to set an output common-mode voltage directly, using two resistors R4 and R5 and a voltage regulator X1. The control signals applied to the driver are analog signals provided by a differential control signal generator as shown, e.g., in FIGURE 6 (in this case, SP = S2,S3 and SN = S1,S4).

[0030] In order to reduce power consumption in the circuit of FIGURE 7 and to reduce loading of load R1, it may be desirable to implement R4 and R5 using relatively large values of effective resistance (i.e. in comparison to the effective resistance value of R1). However, although the output common-mode voltage of this circuit may be well-defined when all of the current-switching transistors (PS1, PS2, NS1, NS2) are off, the driver may experience a problem (e.g. the actual output common-mode voltage may vary) when DC (direct current) resistance values of R4 and R5 are larger than either that of the current source CSP or that of the current sink CSN. Such a situation may occur, for example, when (1) there is a current mismatch between current source CSP and current sink CSN and (2) current source CSP and current sink CSN are short-channel current sources.

[0031] FIGURE 8 demonstrates an example of FIGURE 7 in which specific exemplary values of effective resistances for various elements are shown. In this example, one may appreciate that the actual output common-mode voltage is set not only by the reference potential V_{ref}, but by the rail potential V_{DD} as well. In order to reduce the effect of V_{DD} or V_{GND} on the output common-mode voltage in such a circuit, the resistance values of R4 and R5 must be reduced, which condition may cause loading of the output resistance R1 and/or increased power consumption by the driver circuit. Additionally, reducing the resistances of R4 and R5 may cause an increase in current flow through R4 and R5. Such a situation may require R4 and R5 to

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be wider in order to handle the increase in current flow, thus leading to an increase in chip area.

[0032] Some of the embodiments of the invention as disclosed herein may be applied to address one or more of the problems described above. The solution of such problems should not be taken as a feature, object, or other limitation of the invention, however. Embodiments of the invention may be applied regardless of the presence or solution of any such problems, and the scope of the invention is defined only by the claims of this patent as issued.

[0033] FIGURE 9 shows a schematic diagram of a driver circuit according to an embodiment of the invention that utilizes PMOS (PS1, PS2) and NMOS (NS1, NS2) transistors. In an exemplary embodiment, the bodies of these four transistors are connected to the respective power supply rails as switches (i.e. the bodies of PS1 and PS2 being connected to V_{DD}, and the bodies of NS1 and NS2 being connected to V_{SS}). It may also be desirable for transistors PS1 and PS2 to be matched, and for transistors NS1 and NS2 to be matched.

[0034] The driver circuit also includes a biasing or control circuit 110. This circuit includes transistors PC0 and NC0, which replicate current-sourcing transistor PC1 and current-sinking transistor NC1, respectively; transistors PS0 and NS0, which replicate current-switching transistors PS1/2 and NS1/2, respectively; and resistances R2 and R3, which in series replicate load R1, and at whose junction an offset voltage V_{off} is defined.

[0035] As a result of the duplicated current path, current flowing through PC0 is equal to that through NC0, and thus current through PC1 matches that through NC1. In other words, the current flowing out of the positive terminal of the driver to the load R1 matches the current flowing into the negative terminal from the load R1, thus generating less EMI. For this driver, output common-mode voltage is well-defined by the duplicated current

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path (PC0, PS0, R2, R3, NS0, NC0) and a comparator (the feedback opamp X1). Opamp X1 compares a reference voltage V_{ref} to the offset voltage V_{off} and biases the current-sinking transistors NC0, NC1 to maintain the equivalence of these voltages. Opamp X1 may receive the reference voltage V_{ref} from a node external to (or otherwise independent of) the current paths of the driver circuit. For example, opamp X1 may receive this potential from a reference circuit such as a bandgap reference generator. Opamp X1 may be transconductive such that the offset voltage node is not thereby loaded. Thus an implementation of a circuit as shown in FIGURE 9 may be applied to ensure that both the offset voltage V_{off} and the value of the output common-mode voltage are equal to the reference voltage V_{ref}.

[0036] It may be desirable for transistors PC0 and PC1 to be well-matched. Likewise, it may be desirable for transistors NC0 and NC1 to be well-matched. Uniformity between a pair of nearby circuit elements may be enhanced (e.g. during an etching process) by fabricating one or more dummy elements between them. Therefore, matching of transistors (e.g. PC0 to PC1, and NC0 to NC1) in the circuit of FIGURE 9 may be enhanced by adding dummy transistors between and/or around these transistors during fabrication. FIGURE 10 depicts an implementation of the driver circuit of FIGURE 9 that includes dummy cells NC2, NC3, NC4, PC2, PC3 and PC4 that are fabricated side-by-side between and around NC0 and NC1 and between and around PC0 and PC1.

[0037] In another implementation, dummy cells may be used to enhance matching between current-switching transistors PS1 and PS2, and/or between current-switching transistors NS1 and NS2. However, it should be noted that adding dummy elements reduces available chip area (or, conversely, increases circuit size).

[0038] In a further implementation of a driver circuit as shown in FIGURE 9 or FIGURE 10, the replicate transistors PC0, PS0, NS0, and NC0 are implemented such that their channel width values are a common fraction (1/K) of the respective one of transistors PC1, PS1, NS1 and NC1. In this case, the resistance value of (R2+R3) is implemented to be a common multiple (K) of that of R1. To ensure that the duplicated current flowing through PC0 and NC0 is substantially equal to a fraction (1/K) of the drive current through PC1 and NC1, dummy cells as described above may be placed side-by-side of, e.g., transistors PC0 and PC1 and/or transistors NC0 and NC1.

[0039] In such an implementation, it may be desirable for one of more of the dimensions of each dummy transistor to match the respective dimensions of the adjacent transistor. In a case where the dummy cell is between two transistors of different dimensions, it may be desirable for one or more of the dimensions of the dummy cell to be one of the arithmetic or geometric mean of the respective dimensions of the surrounding transistors. Alternatively, dimensions of dummy cells that alternate in position with current-carrying transistors may be selected to satisfy or approximate a particular arithmetic or geometric progression in conjunction with those of the current-carrying transistors.

[0040] Resistances R2, R3 may be implemented as resistors or as active elements (e.g. MOSFETs) connected to provide fixed (or alternatively, controllable and/or compensating) resistances. Typically R2 and R3 will be implemented to have equal resistances, although other implementations are also possible. In an alternate implementation of a circuit as shown in FIGURE 9 or FIGURE 10, a chip embodying the other elements of the illustrated driver circuit (or only those of the biasing or the current-switching current path) includes pins to which external resistances may be coupled (and, e.g., selected and changed as desired) to serve as the resistances R2, R3.

[0041] As shown in FIGURES 9 and 10, transistor PC5 is coupled to transistors PC0 and PC1 (and possibly to dummy cells) in a current mirror configuration. Other known current mirror configurations may also be used, such as a cascode, Wilson, or modified Wilson current mirror (e.g. as are shown in the text Microelectronic Circuits by Sedra and Smith, 3rd ed. 1991, Oxford Univ. Press).

[0042] FIGURE 11 illustrates a driver circuit according to another embodiment of the invention that includes a control circuit 120. This driver circuit includes two pairs of PMOS (PS1, PS2) and NMOS (NS1, NS2) switches whose bodies may be tied to the positive and negative power supply rails, respectively. This circuit may be implemented such that current source transistor PC1 sources a drive current that is equal to the current of current sink transistor NC1 in order to establish a desired differential output voltage across resistive load R1.

[0043] Instead of using a duplicated biasing circuit (e.g. a mimicking circuit as in FIGURE 4 or a control circuit as in FIGURE 9) to define the output common-mode voltage, control circuit 120 of FIGURE 11 uses a feedback loop including series source-termination resistances R4, R5 and a comparator (here, an operational amplifier X1) to bias current sink transistor NC1. In at least some implementations of this circuit, the sizes of R4 and R5 may be as large as desired, e.g. in order to reduce loading of load resistance R1. Typically R4 and R5 will be implemented to have equal resistances, although other implementations are also possible. A circuit as shown in FIGURE 11 may also be implemented to have a reduced power consumption as compared to a circuit as shown in FIGURE 4 or FIGURE 9 due to a lack of a duplicated biasing circuit.

[0044] Opamp X1 is configured to compare a voltage reference V_{ref} and an observed common-mode voltage. Opamp X1 may receive the

reference voltage V_{ref} from a node external to (or otherwise independent of) the current path of the driver circuit. For example, opamp X1 may receive this potential from a reference circuit such as a bandgap reference generator. Opamp X1 may be transconductive such that the observed voltage node is not loaded. Consequently, operational amplifier X1 regulates the voltage at the node between R4 and R5 to the output voltage reference V_{ref}, setting the output common-mode voltage indirectly via control of current sink NC1. By virtue of the feedback loop formed by X1, NC1, NS1/NS2, R4 and R5, the circuit of FIGURE 11 may be implemented such that the current passing to current sink NC1 is automatically maintained to be equal to the current received from current source PC1.

[0045] Transistor PC5 may be substituted with another current mirror configuration as described above. Likewise, dummy cells may be added as described above to improve matching between pairs of the current-switching transistors (e.g. PS1 and PS2).

[0046] The current-switching transistors PS1, NS1, PS2 and NS2 shown in FIGURES 9, 10 and 11 are controlled by input signals SN and SP applied to their gate terminals (or "control electrodes"). These input signals SN and SP may be complementary rail-to-rail signals provided by a symmetrical control signal generator as shown in FIGURE 12. The method that an input data signal DT1 and a complementary signal DT1N are both sampled by the same clock signal CK1 and the same complementary signal CK1N ensures that the output signals SP and SN have equivalent rising times and equivalent falling times. (Each of the complementary signals DT1N and CK1N may be derived by, e.g., passing the corresponding one of signals DT1 and CK1 through a digital inverter.) As such, the pulse width of a driver circuit as shown in FIGURES 9, 10 and 11 is preserved.

[0047] FIGURE 12 shows a circuit including two identical control cells that may be used to provide rail-to-rail control signals to a driver circuit as described herein (e.g. as shown in FIGURES 2, 4, 5, 7, or 9–11). These control cells do not suffer from duty cycle distortion due to rising and falling time mismatches. As long as there is a symmetrical layout for the two identical rail-to-rail control cells depicted in FIGURE 12, the circuit may be implemented to produce signals SP and SN having equivalent rising times and equivalent falling times such that the output driver's pulse width for on and off signals is preserved.

[0048] Such a circuit may be operated even in the case where complementary signal DT1N is delayed with respect to data signal DT1, or where complementary signal CK1N is delayed with respect to clock signal CK1. Even in this case, so long as the elements of the two control cells are matched, the circuit may be implemented such that the signals SP and SN have equivalent rising times and equivalent falling times.

[0049] In the circuit of FIGURE 12, it is possible that the gates of transistors P3, N3, P7, and N7 may be in a floating state when signal CK1 is low (i.e. when the analog switches P2/N2 and P6/N6 are in an open state). Such a condition may lead to the inverters P3/N3 and P7/N7 having an unstable or wasteful operation. FIGURE 13 shows another implementation of this circuit that may be used to avoid such a condition. This implementation includes analog switches P2A/N2A and P6A/N6A that are in a closed state when the analog switches P2/N2 and P6/N6 are in an open state, and vice versa. Therefore, a floating-gate condition of transistors P3, N3, P7, and N7 may be avoided. FIGURE 14 shows one example of a timing diagram for such a circuit in which signal CK1N is delayed with respect to signal CK1. In particular, this example shows two data value changes between adjacent clock cycles, followed by no data value change between adjacent clock cycles, followed by another data value change. It may be seen that regardless of the

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incoming data values, the signals SP and SN have equivalent rising times and equivalent falling times.

[0050] FIGURE 15 shows a variation of the circuit of FIGURE 13 in which the inverters P1A/N1A and P5A/N5A are omitted. Such a circuit may be applied in cases where the increased load on inverters P1/N1 and P5/P5 is acceptable. Additionally, it may be acceptable in some applications of a circuit as shown in FIGURE 12, 13, or 15 to obtain the output signals directly from the output terminals of the analog switches (i.e. the drain terminals of P2/N2 and P6/N6), although such signals may not be strictly rail-to-rail. In such a case, the inverters P3/N3, P4/N4, P7/N7, and P8/N8 may be omitted.

[0051] The operation of output drivers and the control circuit in accordance with certain embodiments of the present invention may result in several advantages over conventional output drivers and control circuits. As mentioned above, a match between the current flowing out of the positive terminal of a driver circuit as shown in FIGURE 9, 10 and the current flowing into negative terminal may result in reduced EMI emissions. This match of current values may be attributed to both the feedback loop and dummy cells shown in FIGURES 9, 10. The topology used in FIGURE 11 ensures a defined output common-mode voltage as well without resorting to extra duplicated transistors and dummy cells and thus consumes less power. Unlike a circuit as shown in FIGURE 4, the values of R4 and R5 in a driver circuit as shown in FIGURE 11 can be as large as possible in order not to load the output resistor R1. Consequently, such a circuit may be implemented in a smaller circuit area. On the other hand, two identical rail-to-rail control cells as depicted in FIGURES 12, 13, and 15 may be used to drive the input of a driver circuit as shown in either FIGURE 9, 10 or 11 such that the output signals do not suffer from duty cycle distortion due to rising and falling time mismatches, as opposed to a control circuit as shown in FIGURE 3. As noted above, however, such potential advantages of particular embodiments or

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implementations are not to be taken as requirements or limitations of the invention as a whole, whose scope is defined only by the claims as issued. Moreover, in some cases (e.g. instances in which MOS devices are not specifically claimed) the invention may be implemented using active elements (e.g. bipolar transistors, heterojunction devices, metal-insulator-semiconductor FETs (MISFETs), and/or other current-controlling devices) other than those explicitly illustrated or mentioned herein.